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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









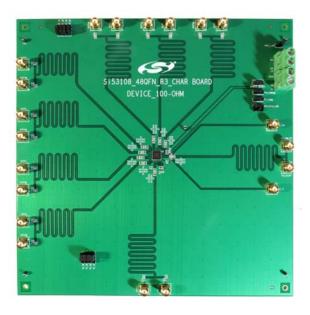
Si53108 EVALUATION BOARD USER'S GUIDE

Description

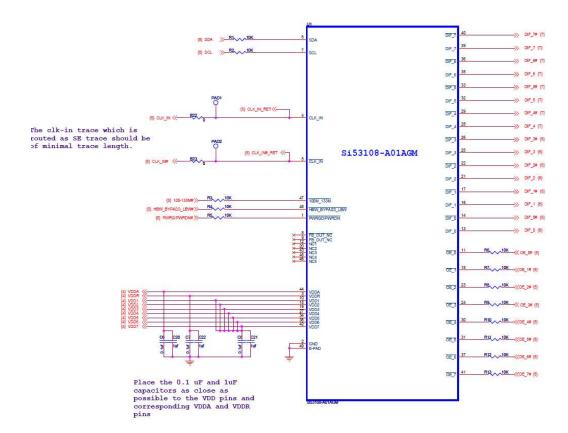
The Si53108-EVB can be used to evaluate the Si53108-A01AGM, an 8-output PCle Gen1/2/3 buffer that can operate in either fanout or zero delay mode.

Features

- 10-inch traces to evaluate signal integrity
- The signal traces of the input and outputs have a single-ended impedance of 50 ohms, and differential impedance of 100 ohms.
- The series resistance on the outputs are set to match to this impedance design.
- DC pin controls per data sheet specification.
- Ability to measure input to output propagation delay.
- Ability to measure PCIe clock jitter.
- Ability to program features of Si53108-A01AGM via I²C interface.



1. Schematics



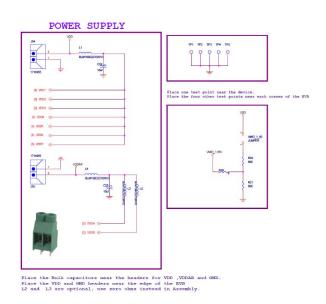


Figure 1. Schematic 1

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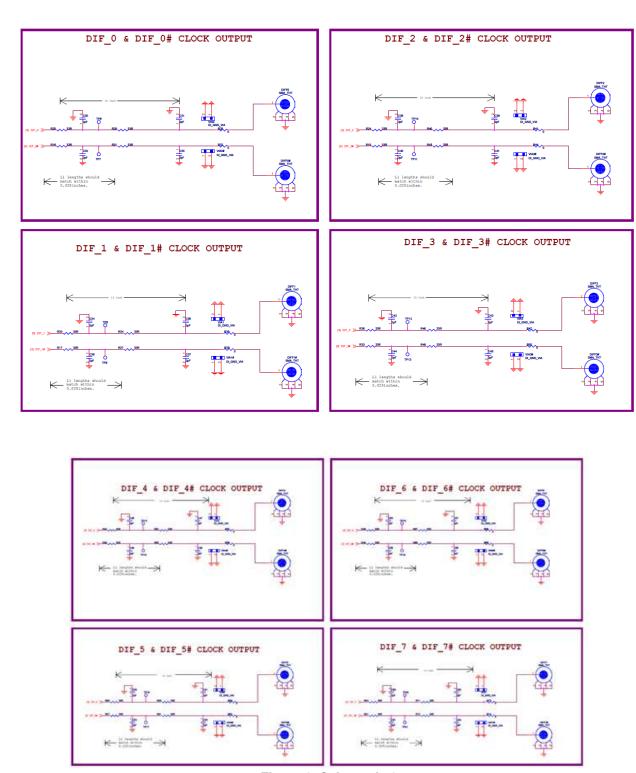


Figure 2. Schematic 2



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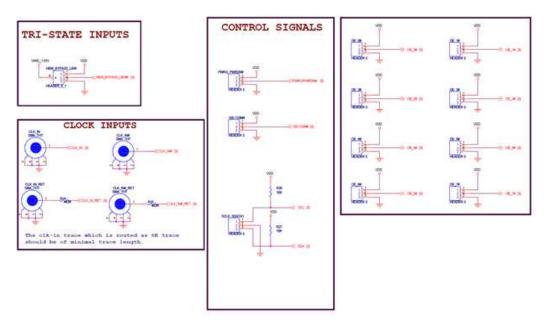


Figure 3. Schematic 3

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2. Input and Power Supply Sequencing

The Si53108-A01AGM should be powered up with supply at both the VDD and VDD_IO nodes (at the jumpers available on the EVB). A 100MHz or 133MHz HCSL input clock should be applied to pins 8 and 9. There is no internal or on-board resistive termination, therefore HCSL termination needs to be provided at the input if needed by the driver. The input clock should be applied only after the supplies are stable.

3. Quick Start Guide:

- 1. Enable supply on the VDD pin.
- 2. Enable supply on the VDDIO pin.
- 3. Apply input clock on the SMA connectors CLK_IN/CLK_IN# and measure the return path clock on CLK_IN_RET, CLK_IN#_RET.

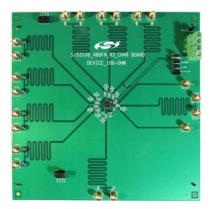


Figure 4. Clock Return Path

- a. The input clock measured at J32, J33 needs a 50-ohm termination on the scope.
- b. The attenuation will be 1:10 after the above termination. Appropriate scaling (10x) needs to be set at the scope to adjust for the scaling.
- 4. The output clocks are now set up and can be measured on an oscilloscope or frequency domain measurement instrument.

4. Usage of the EVB

- 1. Once the EVB has been set up, the following can be evaluated:
- 2. Signal integrity of the device when driving 10-inch, 100-ohm differential traces.
- 3. Effect of capacitance load on output signal integrity.
- 4. Output-to-output skew over 10-inch traces.
- 5. Input-to-output prorogation delay in BYPASS, HBW, and LBW modes using the input clock return path.
- 6. Measuring the power consumption of the device.
- 7. Modification of the device settings via the I²C interface.



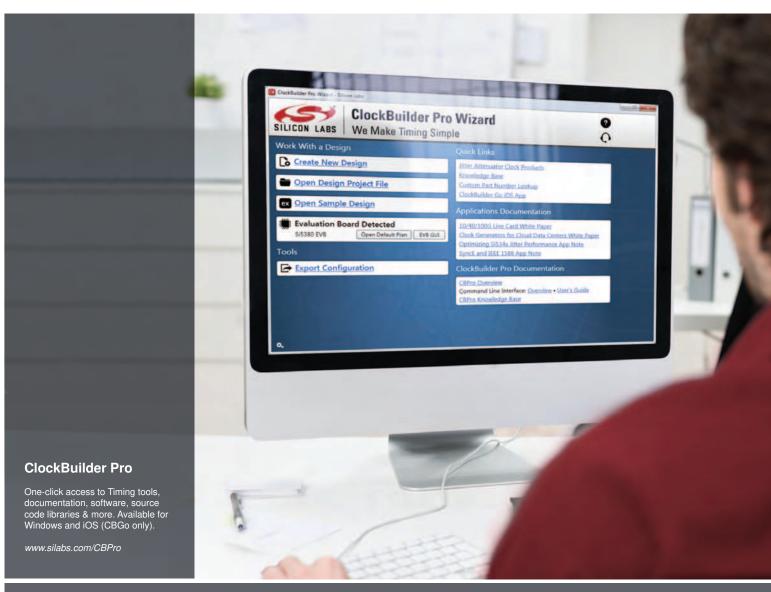
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5. Bill of Materials

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9 1- 8	C42,C43,C44,C46,C46,C47,						
10 P- 01	C48 C49 C50 C51 C52 C53						
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	4 1,12,13,14	BLM15B0221SN1D	L0402	BLM15BD221SN1D	FERRITE CHIP 220 OHM 300MA 0402	Murata Electronics North America	200000000000000000000000000000000000000
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-	R27					60	
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13	32 R16,R17,R18,R24,R25,R28,	33R	RC0402	ERU-2RKF33R0X	RES 33.0 OHM 1/10W 1% 0402 SMD	Panasonic - ECG	
	R30 R31 R33 R34 R36 R37						
-	SAC SAC EAC CAC ALC SEC						
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1	K48, K43, K51, K52, K54, K55,						
1	R57, R58, R60, R61, R61, R68,						
	R71,R72						
14	19 R19, R22, R23, R29, R32, R35,	0	RC0402	RC0402JR-070RL	RES 0.0 OHM 1/16W 0402 SMD	Yageo	950
	R38,R41,R44,R47,R50,R53,		12				12
	R56.R59.R62.R65.R66.R73.						
	R74						
15	2 R20 R21	50%	RC0402	RC0402FR-0749k9	RES 49 9K OHM 1/16W 1% 0402 SMD	Yaoeo	
10	5 TP1 TP2 TP3 TP4 TP5	TPOINTB	4	5001	TEST POMIT PC MMII 040"D BLACK	Kevstone Electronics	Component Reference-305-PD:13-1158
17	16 TPG TP7 TP8 TP9 TP10	TPOINTB	TESTPOINT				NOT A PART
-	TP11 TP12 TP13 TP14 TP16						
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